

09-18-2001

U.S. DEPARTMENT OF COMMERCE
PATENT AND TRADEMARK OFFICE



HEET

101846808

TO THE HONORABLE DIRECTOR OF THE UNITED STATES PATENT AND TRADEMARK OFFICE. PLEASE RECORD THE ATTACHED ORIGINAL DOCUMENTS OR COPY THEREOF.

1. Name of conveying party(ies):

(a) Hendrik T. Mau

(b)

(c)

Additional name(s) of conveying party(ies) attached?

Yes No

2. Name and address of receiving party(ies):

Name: Sun Microsystems, Inc.

Street Address: 901 San Antonio Road, MS PAL01-5211

City: Palo Alto CA 94303

Country: USA

JC997 U.S. PTD
09/949068
09/07/01

3. Nature of Conveyance:

Assignment Merger

Security Agreement Change of Name

Other _____

Execution Date: August 28, 2001

Name and address of receiving party(ies):

Name:

Street Address:

City: State: Zip:

Country:

Additional name(s) & address(es) attached?

Yes No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: August 28, 2001

A. Patent Application No.(s) - 09/949068

Title: Designing Integrated Circuits to Reduce Electromigration Effects

B. Patent No.(s)

Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Stephen A. Terrile

Internal Address: SKJERVEN MORRILL MacPHERSON LLP

Street Address: 25 METRO DRIVE, SUITE 700

City SAN JOSE State CA Zip 95110

6. Total number of applications and patents involved: 1

09/17/2001 DBYRNE 00000190 192386 09949068

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7. Total fee (37 CFR 3.41): \$40.00

Authorized to be charged to Deposit Account 19-2386

Charge Deposit Account 19-2386 for any additional fees required for this conveyance and credit deposit account 19-2386 any amounts overpaid

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8. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Stephen A. Terrile
Name of Person Signing

Signature

9/17/01
Date

Total number of pages including cover sheet, attachments, and documents. 1

ASSIGNMENT

For good and valuable consideration, receipt of which is hereby acknowledged, I, Hendrik T. Mau, of Santa Clara, California, hereby sell, assign and transfer to Sun Microsystems, Inc., a Delaware corporation, having a place of business at 901 San Antonio Road, MS PALO1-521, Palo Alto California 94303, its successors and assigns, the entire right, title and interest throughout the world in my invention in

**DESIGNING INTEGRATED CIRCUITS TO REDUCE
ELECTROMIGRATION EFFECTS**

for which I have executed a United States patent application on or about the date of this assignment, and all patent applications and patents of every country for said invention, including divisions, reissues, continuations and extensions thereof, and all rights of priority resulting from the filing of said applications; I authorize the above-named assignee to apply for patents of foreign countries for said invention, and to claim all rights of priority without further authorization from me; I agree to execute all papers useful in connection with said United States and foreign applications, and generally to do everything possible to aid said assignee, its successors, assigns and nominees, at their request and expense, in obtaining and enforcing patents for said invention in all countries; and I request the Commissioner of Patents and Trademarks to issue all patents granted for said invention to the above-named assignee, its successors and assigns.

Executed this 28 day of August, 2001.



Hendrik T. Mau